

Overview

The R49 is constructed of metallized polypropylene film encapsulated with self-extinguishing resin in a box of material meeting the requirements of UL 94 V-0.

Applications

For use as electromagnetic interference, (EMI) suppression filter in across-the-line applications requires X1 safety classification. Intended for the use in situations where exposure to shock in the event of capacitor failure is not possible. Not for use in "series with mains" type applications. X1 classified capacitors are only for the use in a permanently connected apparatus with a connection to mains, which cannot be loosened without the use of a tool.

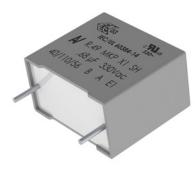
Benefits

- Approvals: ENEC, UL, cUL
- Class X1 (IEC 60384-14)
- Rated voltage: 330 VAC 50/60 Hz
- Capacitance range: 0.047 6.8 μF
- Lead spacing: 15.0 37.5 mm
- Capacitance tolerance: ±20%, ±10%
- Climatic category: 40/110/56, IEC 60068-1
- Tape and reel in accordance with IEC 60286-2
- · RoHS Compliant and lead-free terminations
- Operating temperature range of -40°C to +110°C
- 100% screening factory test at 2,200 VDC/1,500 VAC
- · Self-healing properties

Part Number System

R49	Α	N	3150	00	B 1	М
Series	Rated Voltage (VAC)	Lead Spacing (mm)	Capacitance Code (pF)	Lead and Packaging Code	Internal Use	Capacitance Tolerance
X1, Metallized Polypropylene	A = 330	l = 15.0 N = 22.5 R = 27.5 W = 37.5	The last three digits represent significant figures. The first digit specifies number of zeros to be added.	See Ordering Options Table	A1 A2 A3 B1 B2	K = ±10% M = ±20%







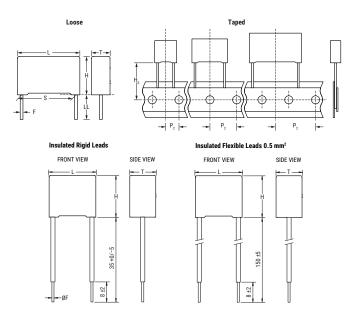
Ordering Options Table

Lead Spacing Nominal (mm)	Type of Leads and Packaging	Lead Length (mm)	Lead and Packaging Code
	Standard Lead and Packaging Options		
	Bulk (Bag) – Short Leads	4 +2/-0	00
	Ammo Pack	H ₀ = 18.5 ±0.5	DQ
	Other Lead and Packaging Options		
	Tape & Reel (Large Reel)	H ₀ = 18.5 ±0.5	СК
10,	Bulk (Bag) – Short Leads	3.5 +0.5/-0	JB
15,	Bulk (Bag) – Short Leads	4.0 +0.5/-0	JE
22.5	Bulk (Bag) – Short Leads	3.2 +0.3/-0.2	JH
	Bulk (Bag) – Long Leads	18 ±1	JM
	Bulk (Bag) – Long Leads	30 +5/-0	40
	Bulk (Bag) – Long Leads	25 +2/-1	50
	Bulk (Bag) – Insulated Rigid Leads	30 +5/-0 (sp 8 ±2)	51
	Bulk (Bag) – Insulated Flexible Leads	150 ±5 (sp 8 ±2)	52
	Standard Lead and Packaging Options		
	Bulk (Tray) – Short Leads	4 +2/-0	00
	Tape & Reel (Large Reel)	H ₀ = 18.5 ±0.5	CK ¹
27.5	Other Lead and Packaging Options		
	Bulk (Tray) – Long Leads	30 +5/-0	40
	Bulk (Tray) – Long Leads	25 +2/-1	50
	Bulk (Bag) – Insulated Rigid Leads	30 +5/-0 (sp 8 ±2)	51
	Bulk (Bag) – Insulated Flexible Leads	150 ±5 (sp 8 ±2)	52
	Standard Lead and Packaging Options		
	Bulk (Tray) – Short Leads	4 +2/-0	00
	Other Lead and Packaging Options	1.2/0	
37.5	Bulk (Tray) – Long Leads	30 +5/-0	40
	Bulk (Tray) – Long Leads	25 +2/-1	50
	Bulk (Bag) – Insulated Rigid Leads	30 +5/-0 (sp 8 ±2)	50
	Bulk (Bag) – Insulated Flexible Leads	150 ±5 (sp 8 ±2)	52

¹ Not for all sizes, see "Packaging Quantities" table



Dimensions – Millimeters



	S		Г		H			F	
Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance
15.0	±0.4	5.0	+0.2/-0.5	11.0	+0.1/-0.5	18.0	+0.3/-0.5	0.6	±0.05
15.0	±0.4	6.0	+0.2/-0.5	12.0	+0.1/-0.5	18.0	+0.3/-0.5	0.6	±0.05
15.0	±0.4	6.0	+0.2/-0.5	17.5	+0.1/-0.5	18.0	+0.3/-0.5	0.6	±0.05
15.0	±0.4	8.5	+0.2/-0.5	14.5	+0.1/-0.5	18.0	+0.5/-0.5	0.6	±0.05
15.0	±0.4	10.0	+0.2/-0.5	16.0	+0.1/-0.5	18.0	+0.6/-0.5	0.8	±0.05
15.0	±0.4	11.0	+0.2/-0.5	19.0	+0.1/-0.5	18.0	+0.7/-0.5	0.8	±0.05
15.0	±0.4	13.0	+0.2/-0.5	12.0	+0.1/-0.5	18.0	+0.8/-0.5	0.8	±0.05
22.5	±0.4	6.0	+0.2/-0.5	15.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
22.5	±0.4	7.0	+0.2/-0.5	16.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
22.5	±0.4	8.5	+0.2/-0.5	17.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
22.5	±0.4	10.0	+0.2/-0.5	18.5	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
22.5	±0.4	13.0	+0.2/-0.5	22.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
27.5	±0.4	9.0	+0.2/-0.7	17.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
27.5	±0.4	11.0	+0.2/-0.7	20.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
27.5	±0.4	13.0	+0.2/-0.7	22.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
27.5	±0.4	13.0	+0.2/-0.7	25.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
27.5	±0.4	14.0	+0.2/-0.7	28.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
27.5	±0.4	18.0	+0.2/-0.7	33.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
27.5	±0.4	22.0	+0.2/-0.7	37.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
37.5	±0.4	11.0	+0.3/-0.7	22.0	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05
37.5	±0.4	13.0	+0.3/-0.7	24.0	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05
37.5	±0.4	16.0	+0.3/-0.7	28.5	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05
37.5	±0.4	19.0	+0.3/-0.7	32.0	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05
37.5	±0.4	30.0	+0.3/-0.7	45.0	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05
		Note:	See Ordering	Options Tab	le for lead leng	th (LL/H₀) op	tions.		



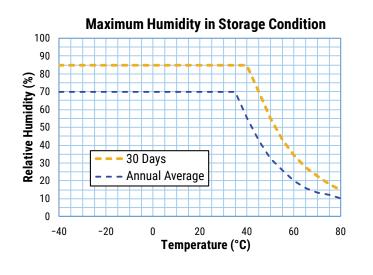
Performance Characteristics

Dielectric	Polypropylene film	Polypropylene film					
Plates	Metal layer deposited by	evaporation under vacuum					
Winding	Non-inductive type	Non-inductive type					
Leads	Tinned wire						
Protection	Plastic case, thermosetting	g resin filled. Box material is s	olvent resistant and flame reta	ardant according to UL94.			
Related documents	IEC 60384-14, EN 60384-	14					
Rated Voltage (V _R)	330 VAC (50/60 Hz)						
Recommended DC Voltage	800 VDC						
Capacitance Range	0.047 – 6.8 µF						
Capacitance Values	E6 series (IEC 60063)						
Capacitance Tolerance	±10%, ±20%	±10%, ±20%					
Temperature Range	-40° to +110°C						
Climatic Category	40/110/56 IEC 60068-1						
	Storage time: \leq 24 months from the date marked on the label package						
	Average relative humidity	Average relative humidity per year ≤ 70%					
Storage Conditions	RH ≤ 85% for 30 days ran	domly distributed througho	ut the year				
	Dew is absent						
	Temperature: -40 to 80°0	C (see "Maximum Humidity	in Storage Conditions" grap	h below)			
Approvals	ENEC, UL, cUL						
Dissipation Factor (tanδ)	≤ 0.1% (0.06%*) at 1 kHz,	+25°C ±5°C (* typical value)				
Test Voltage Between Terminals	The 100% screening factory test is carried out at 2,200 VDC/1,500 VAC. The voltage level is selected to meet the requirements in applicable equipment standards. All electrical characteristics are checked after the test. It is not permitted to repeat this test as there is a risk to damage the capacitor. KEMET is not liable in such case for any failures.						
		Measured at +25°C ±5°C,	according to IEC 60384–2				
		Minimum Values E	Between Terminals				
Insulation Resistance	Voltage Charge	Voltage Charge Time	C ≤ 0.33 µF	C > 0.33 µF			
	100 VDC	1 minute	≥ 1 • 10⁵ MΩ (≥ 5 • 10⁵ MΩ)*	≥ 30,000 MΩ • μF (≥ 150,000 MΩ • μF)*			

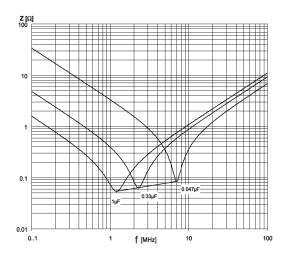
* Typical value



Performance Characteristics cont.



Impedance Graph





Environmental Test Data

Test	IEC Publication	Procedure
Endurance	EN/IEC 60384-14	1.25 x V _R VAC 50 Hz, once every hour increase to 1,000 VAC for 0.1 second, 1,000 hours at upper rated temperature
Vibration	IEC 60068-2-6 Test Fc	3 directions at 2 hours each 10 – 55 Hz at 0.75 mm or 98 m/s 2
Bump	IEC 60068-2-29 Test Eb	1,000 bumps at 390 m/s ²
Change of Temperature	IEC 60068-2-14 Test Na	Upper and lower rated temperature 5 cycles
Active Flammability	IEC 60384-14	V_{R} +20 surge pulses at 4 kV (pulse every 5 seconds)
Passive Flammability	IEC 60384-14	IEC 60384-1, IEC 60695-11-5 Needle flame test
Damp Heat Steady State	IEC 60068-2-78 Test Cab	+40°C and 93% RH, 56 days

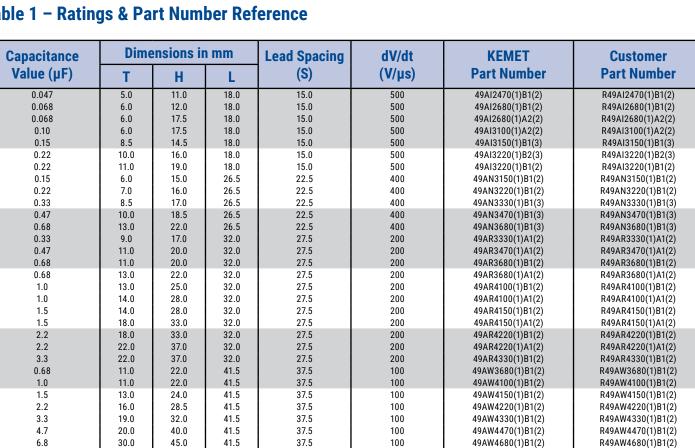
Approvals

Certification Body	Mark	Specification	File Number
IMQ S.p.A.		EN/IEC 60384-14	CA08.00030
UL	c FL [®] us	UL 60384-14 and CAN/CSA E60384-14 (330 VAC)	E97797

Environmental Compliance

All KEMET EMI capacitors are RoHS Compliant.





Lead

Spacing (S)

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dV/dt (V/µs)

(1) Insert lead and packaging code. See Ordering Options Table for available options.

L (mm)

H (mm)

(2) $M = \pm 20\%$, $K = \pm 10\%$

Capacitance Value (µF)

(3) M = ±20% (only available tolerance).

T (mm)

Customer

Part Number

KEMET

Part Number





Soldering Process

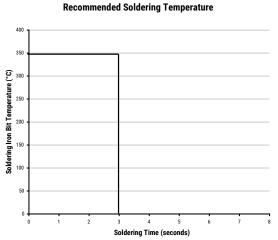
The implementation of the RoHS directive has resulted in the selection of SnAgCu (SAC) alloys or SnCu alloys as primary solder. This has increased the liquidus temperature from that of 183°C for SnPb eutectic alloy to 217 - 221°C for the new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher pre-heat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is 160 – 170°C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 mm to 15 mm), and great care has to be taken during soldering. The recommended solder profiles from KEMET should be used. Please consult KEMET with any questions. In general, the wave soldering curve from IEC Publication 61760-1 Edition 2 serves as a solid guideline for successful soldering. Please see Figure 1.

Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the above the recommended limits may result to degradation or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface mount components. Insert through-hole parts after the curing of surface mount parts. Consult KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum two soldering cycles is recommended. Please allow time for the capacitor surface temperature to return to a normal temperature before the second soldering cycle.

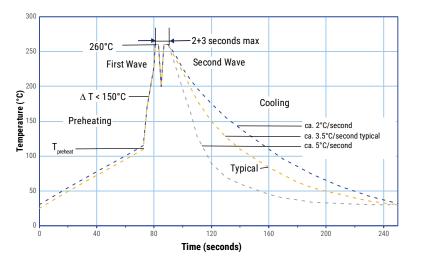
Manual Soldering Recommendations

The following is the recommendation for manual soldering with a soldering iron.



The soldering iron tip temperature should be set at 350°C (+10°C maximum) with the soldering duration not to exceed more than 3 seconds.

Wave Soldering Recommendations





Soldering Process cont.

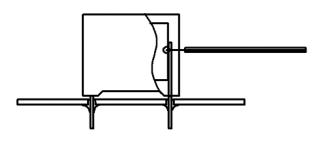
Wave Soldering Recommendations cont.

1. The table indicates the maximum set-up temperature of the soldering process Figure 1

Dielectric	Pre	mum heat erature	Maximum Peak Soldering Temperature		
Film Material	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm	
Polyester	130°C	130°C	270°C	270°C	
Polypropylene	110°C	130°C	260°C	270°C	
Paper	130°C	140°C	270°C	270°C	
Polyphenylene Sulphide	150°C	160°C	270°C	270°C	

The maximum temperature measured inside the capacitor: Set the temperature so that inside the element the maximum temperature is below the limit:

Dielectric Film Material	Maximum temperature measured inside the element		
Polyester	160°C		
Polypropylene	110°C		
Paper	160°C		
Polyphenylene sulphide	160°C		



Temperature monitored inside the capacitor.

Selective Soldering Recommendations

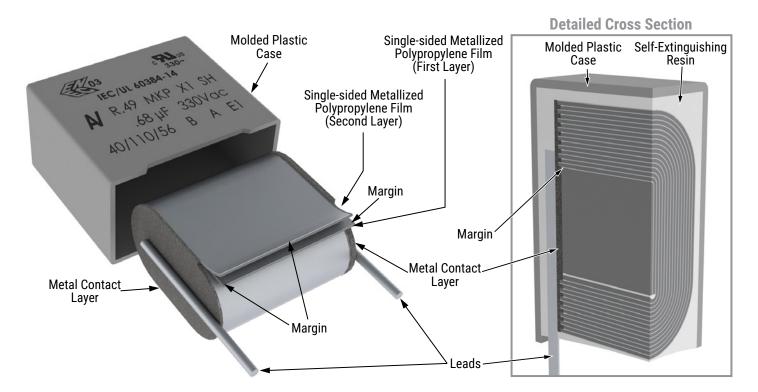
Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath as in normal flow soldering without touching the solder. When the board is over the bath, it is stopped and pre-designed solder pots are lifted from the bath with molten solder only at the places of the selected components, and pressed against the lower surface of the board to solder the components.

The temperature profile for selective soldering is similar to the double wave flow soldering outlined in this document, **however, instead of two baths, there is only one bath with a time from 3 to 10 seconds.** In selective soldering, the risk of overheating is greater than in double wave flow soldering, and great care must be taken so that the parts are not overheated.

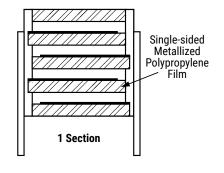
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Construction



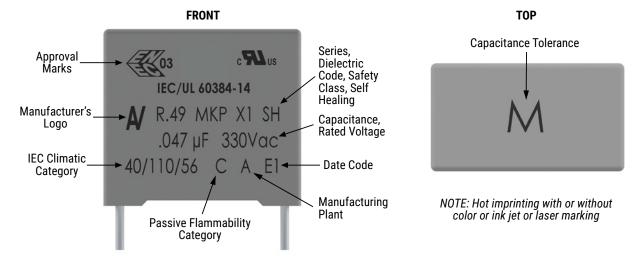
Winding Scheme



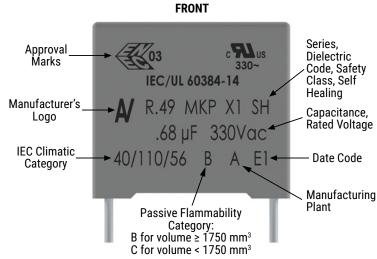


Marking

Lead Spacing 10 mm



Lead Spacing 15 mm, 22.5 mm (small case sizes)



NOTE: Hot imprinting with or without

color or ink jet or laser marking

TOP

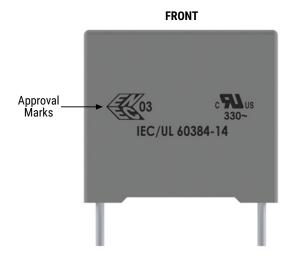
Capacitance Tolerance

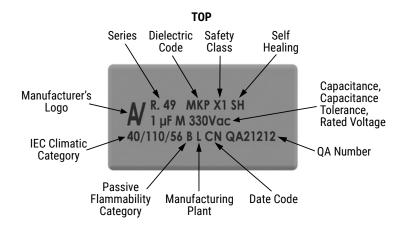
* Differences caused by technology (clichee, laser or ink jet) and production line



Marking cont.

Lead Spacing 22.5 and 27.5 mm (alternatives*) and 37.5 mm





* Differences caused by technology (clichee, laser or ink jet) and production line

Manufacturing Date Code (IEC 60062)								
	Y = Year, Z = Month							
Year	Code	Month	Code					
2010	A	January	1					
2011	В	February	2					
2012	С	March	3					
2013	D	April	4					
2014	E	May	5					
2015	F	June	6					
2016	Н	July	7					
2017	J	August	8					
2018	K	September	9					
2019	L	October	0					
2020	М	November	Ν					
2021	N	December	D					
2022	Р							
2023	R							
2024	S							
2025	Т							
2026	U							
2027	V							
2028	W							
2029	X							
2030	A							



Packaging Quantities

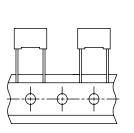
Lead Spacing (mm)	Thickness (mm)	Height (mm)	Length (mm)	Bulk Short Leads	Bulk Long Leads	Standard Reel ø 355 mm	Large Reel ø 500 mm	Ammo Taped
	5.0	11.0	18.0	2,000	1,000	600	1,250	800
	6.0	12.0	18.0	1,750	900	500	1,000	680
	6.0	17.5	18.0	1,000	700	500	1,000	680
15	8.5	14.5	18.0	1,000	500	300	700	440
	10.0	16.0	18.0	750	500	300	600	380
	11.0	19.0	18.0	450	350	-	500	340
	13.0	12.0	18.0	750	490	200	480	280
	()	15.0	ОС Г	0.05	500	_	700	464
	6.0	15.0	26.5	805	500		700	464
00 F	7.0	16.0	26.5	700	500	-	550	380
22.5	8.5	17.0	26.5	468	300	-	450	280
	10.0	18.5	26.5	396	300	-	350	235
	13.0	22.0	26.5	300	200	-	300	-
	9.0	17.0	32.0	816	408	_	450	-
	11.0	20.0	32.0	560	336	_	350	-
	13.0	22.0	32.0	480	288	_	300	-
27.5	13.0	25.0	32.0	480	288	-	-	-
	14.0	28.0	32.0	352	176	-	-	-
	18.0	33.0	32.0	256	128	-	-	-
	22.0	37.0	32.0	168	112	-	_	-
	11.0	22.0	41.5	420	252		-	-
	13.0	24.0	41.5	360	216	_	-	-
37.5	16.0	28.5	41.5	216	108	-	-	-
	19.0	32.0	41.5	192	96	_	-	-
	30.0	45.0	41.5	90	60	-	_	-



Lead Taping & Packaging (IEC 60286-2)



Figure 2 Lead Spacing 15 mm



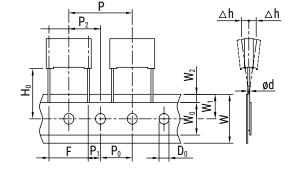
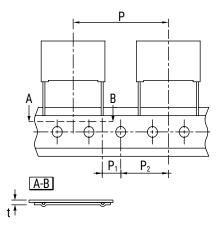


Figure 3 Lead Spacing 22.5 – 27.5 mm



Taping Specification

			Dim	ensions (r	nm)	
Description	Symbol		Lead			
Description	Cymbol	10	15	22.5	27.5	Tol.
		Fig. 1	Fig. 2	Fig. 3	Fig. 3	
Lead wire diameter	d	0.6	0.6-0.8	0.8	0.8	±0.05
Taping lead space	Р	25.4	25.4	38.1	38.1	±1
Feed hole lead space *	P ₀	12.7	12.7	12.7	12.7	±0.2 **
Centering of the lead wire	P ₁	7.7	5.2	7.8	5.3	±0.7
Centering of the body	P ₂	12.7	12.7	19.05	19.05	±1.3
Lead spacing (pitch) ***	F	10	15	22.5	27.5	+0.6/-0.1
Component alignment	Δh	0	0	0	0	±2
Height of component from tape center	H ₀ ****	18.5	18.5	18.5	18.5	±0.5
Carrier tape width	W	18	18	18	18	+1/-0.5
Hold down tape width	W ₀	9	10	10	10	Minimum
Hole position	W ₁	9	9	9	9	±0.5
Hold down tape position	W ₂	3	3	3	3	Maximum
Feed hole diameter	D ₀	4	4	4	4	±0.2
Total tape thickness	t	0.7	0.7	0.7	0.7	±0.2

* 15 mm also available

** Maximum of 1 mm on 20 lead spaces

*** Pitches 15 mm and 10 mm taped to 7.5 mm (crimped leads) available upon request

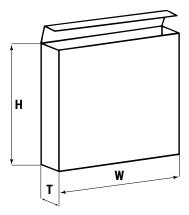
**** $H_0 = 16.5 \text{ mm}$ is available upon request



Lead Taping & Packaging (IEC 60286-2) cont.

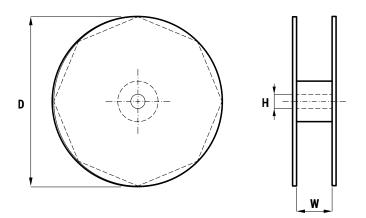
Ammo Specifications

Dimensions (mm)					
H W T					
360	340	59			



Reel Specifications

Reel Size	Dimensions (mm)		
	D	Н	W
Standard	355	30	55 Maximum
Large	500	25	





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Although all product-related warnings, cautions and notes must be observed, the customer should not assume that all safety measures are indicted or that other measures may not be required.

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